S65	1	361/508 and polymer and compound and conjugat\$3 adj polymer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/25 18:43
S66	0	361/509 and polymer and compound and conjugat\$3 adj polymer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/25 18:50
S67	0	361/520 and polymer and compound and conjugat\$3 adj polymer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON -	2005/05/25 18:52
S68	1	361/530 and polymer and compound and conjugat\$3 adj polymer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/25 18:53
S69	0	361/503 and polymer and compound and conjugat\$3 adj polymer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/25 18:53
S70	3	361/502 and polymer and compound and conjugat\$3 adj polymer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/26 08:58
S71	96	wiring adj board and(349/149-150).ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/26 09:01
S72	9	S71 and(conductive adj layer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/26 09:01

S81	376	S80 and(substrate)	US-PGPUB;	OR	ON	2005/05/26 09:57
		,	USPAT;	J		
			USOCR;			
			EPO; JPO;			
			DERWENT;			
			IBM_TDB			
S82	227	S81 and(interconect\$3 or via\$1)	US-PGPUB;	OR	ON	
			USPAT;			, , , , , , , , , , , , , , , , , , , ,
			USOCR;			
			EPO; JPO;			
			DERWENT;			
			IBM_TDB			

S73	0	S71 and(bank)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/26 09:01
S74	215	wiring adj board and(174/252-254).ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/26 09:06
S75		S74 and(bank)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/26 09:01
S76	0	electro adj optical adj device.ti. and S74	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/26 09:07
S77	64	electro adj optical adj device.ti. and wiring adj board	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/26 09:40
S78	6	S77 and(bank)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/26 09:56
S79	813	wiring adj board and bank	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/26 09:56
S80	407	S79 and(electrode\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/26 09:57